



INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification ⁶ : G02B 26/00	A1	(11) International Publication Number: WO 97/17628 (43) International Publication Date: 15 May 1997 (15.05.97)
--	-----------	--

(21) International Application Number: PCT/US96/17731

(22) International Filing Date: 6 November 1996 (06.11.96)

(30) Priority Data:
08/554,630 6 November 1995 (06.11.95) US

(71) Applicant: ETALON, INC. [US/US]; 33 Hanson Street #2, Boston, MA 02118 (US).

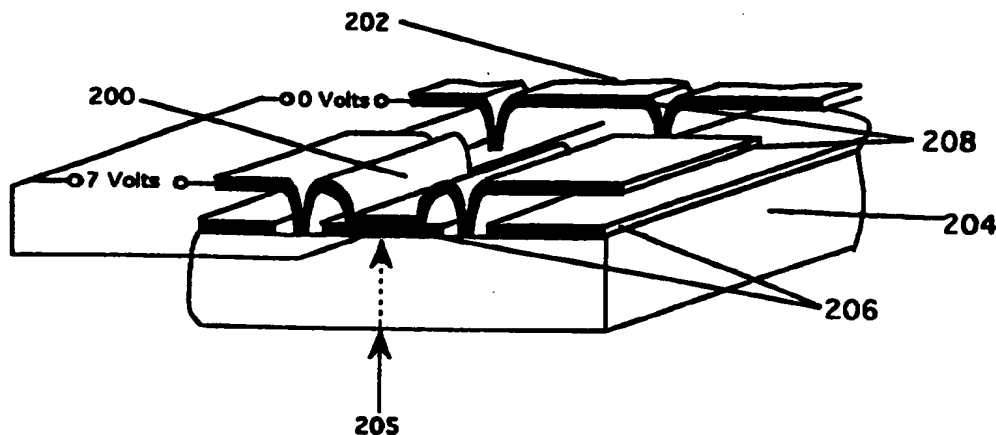
(72) Inventor: MILES, Mark, W.; 33 Hanson Street #2, Boston, MA 02118 (US).

(74) Agent: FEIGENBAUM, David, L.; Fish & Richardson P.C., 225 Franklin Street, Boston, MA 02110-2804 (US).

(81) Designated States: JP, European patent (AT, BE, CH, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).

Published
With international search report.

(54) Title: INTERFEROMETRIC MODULATION



(57) Abstract

an interferometric modulator cavity (200, 202) has a reflector (208) and an induced absorber (206). A direct view reflective flat panel display may include an array of the modulators. Adjacent spacers of different thicknesses are fabricated on a substrate (204) by a lift-off technique used to pattern the spacers which are deposited separately, each deposition providing a different thickness of spacer. Alternately, a patterned photoresist may be used to allow for an etching process to selectively etch back the thickness of a spacer which was deposited in a single deposition. A full-color static graphical image may be formed of combined patterns of interferometric modulator cavities (200, 202). Each cavity includes a reflector (208), and an induced absorber (206), the induced absorber (206) including a spacer having a thickness that defines a color associated with the cavity.

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AM	Armenia	GB	United Kingdom	MW	Malawi
AT	Austria	GE	Georgia	MX	Mexico
AU	Australia	GN	Guinea	NE	Niger
BB	Barbados	GR	Greece	NL	Netherlands
BE	Belgium	HU	Hungary	NO	Norway
BF	Burkina Faso	IE	Ireland	NZ	New Zealand
BG	Bulgaria	IT	Italy	PL	Poland
BJ	Benin	JP	Japan	PT	Portugal
BR	Brazil	KE	Kenya	RO	Romania
BY	Belarus	KG	Kyrgyzstan	RU	Russian Federation
CA	Canada	KP	Democratic People's Republic of Korea	SD	Sudan
CF	Central African Republic	KR	Republic of Korea	SE	Sweden
CG	Congo	KZ	Kazakhstan	SG	Singapore
CH	Switzerland	LI	Liechtenstein	SI	Slovenia
CI	Côte d'Ivoire	LK	Sri Lanka	SK	Slovakia
CM	Cameroon	LR	Liberia	SN	Senegal
CN	China	LT	Lithuania	SZ	Swaziland
CS	Czechoslovakia	LU	Luxembourg	TD	Chad
CZ	Czech Republic	LV	Latvia	TG	Togo
DE	Germany	MC	Monaco	TJ	Tajikistan
DK	Denmark	MD	Republic of Moldova	TT	Trinidad and Tobago
EE	Estonia	MG	Madagascar	UA	Ukraine
ES	Spain	ML	Mali	UG	Uganda
FI	Finland	MN	Mongolia	US	United States of America
FR	France	MR	Mauritania	UZ	Uzbekistan
GA	Gabon			VN	Viet Nam

- 1 -

INTERFEROMETRIC MODULATION

Background

This is a continuation in part of United States
5 Patent Application Serial Number 08/238,750, filed May 5,
1994, and incorporated by reference.

This invention relates to visible spectrum
(including ultra-violet and infrared) modulator arrays.

The parent application describes two kinds of
10 structures whose impedance, the reciprocal of admittance,
can be actively modified so that they can modulate light.
One scheme is a deformable cavity whose optical
properties can be altered by electrostatic deformation of
one of the cavity walls. The composition and thickness
15 of these walls, which consist of layers of dielectric,
semiconductor, or metallic films, allows for a variety of
modulator designs exhibiting different optical responses
to applied voltages.

One such design includes a filter described as a
20 hybrid filter which has a narrow bandpass filter and an
induced absorber. When the wall associated with the
hybrid filter is brought into contact with a reflector,
incident light of a certain range is absorbed. This
occurs because the induced absorber matches the impedance
25 of the reflector to that of the incident medium for the
range of frequencies passed by the narrow-band filter.

Summary

This invention eliminates the need for the narrow-
band filter and provides a much broader absorption range.

30 The invention modulates light by electrostatically
varying the spacing of a cavity comprising two walls, one
of which is a reflector and the other is the induced
absorber. The cavity is fabricated on an optically
smooth substrate, i.e., sufficiently smooth to allow for
35 the manifestation of interference effects.

- 2 -

Thus, in general, in one aspect the invention features an interferometric modulator cavity having a reflector and an induced absorber.

Implementations of the invention may include one
5 or more of the following features. The reflector may include films of metal, dielectric, semiconductor, or a combination of them. The induced absorber may include a sandwich of an absorber between two matching layers. One of the matching layers may reside at the boundary of the
10 absorber with an incident medium and the other matching layer may reside at the boundary of the absorber with the reflector. At least one of the matching layers may include a film of metal. At least one of the matching layers may include a dielectric film, or a semiconducting
15 film, or a combination of at least two of a metal film, a dielectric film, and a semiconducting film. The absorber may include a high loss film such as a metal, or a high loss film such as a semiconductor, or a combination of a metal and semiconducting film. There may also be a
20 substrate which includes a transparent incident medium. The induced absorber and/or the reflector may reside on the substrate. The substrate may be transparent, in which case it could also act as the incident medium, or opaque. The spacer may be air or some other pliant
25 medium (e.g., liquid or plastic) which would allow the thickness of the gap to be altered.

In general, in another aspect, the invention features a direct view reflective flat panel display comprising an array of interferometric modulators.

30 Implementations of the invention may include one or more of the following. The array may include sets of the interferometric modulators, the respective sets being arranged to switch between different pairs of reflective states. The array may include a single set of
35 interferometric modulators, the set being arranged to be

- 3 -

driven in an analog fashion to reflect any particular color. The brightness of each of the modulators is controlled by pulse width modulation, or by spatial dithering, or by a combination of the two. The array may
5 be sealed by a backplane. The backplane may include a monolithic element. The backplane may be attached. The backplane may support electrodes which modify the electromechanical response of the pixels. Each of the modulators may be actuated by electrostatic forces or by
10 piezoelectric forces or by magnetic forces. The display may be used in a projection system. An optical compensation mechanism may be used to mitigate or eliminate a shift in color with respect to viewing angle or to provide supplemental frontlighting or to mitigate
15 or eliminate a shift in color with respect to viewing angle. The substrate may be an integrated circuit.

In general, in another aspect, the invention features a process for fabricating adjacent spacers of different thicknesses on a substrate in which a lift-off
20 technique is used to pattern the spacers which are deposited separately, each deposition providing a different thickness of spacer. Or a patterned photoresist may be used to allow for an etching process to selectively etch back the thickness of a spacer which
25 was deposited in a single deposition.

In general, in another aspect, the invention features a full-color static graphical image comprising an array of interferometric modulator cavities. Each cavity includes a reflector, and an induced absorber, the
30 induced absorber including a spacer having a thickness that defines a color associated with the cavity.

In general, in another aspect, the invention features a full-color static graphical image comprising separate patterns of spacers or interferometric modulator
35 cavities with spacers, in each pattern the spacer having

- 4 -

a thickness which defines a color associated with the pattern which when all patterns are combined produces the image.

Among the advantages of the invention may be one or more of the following. High quality full-color flat panel displays may be made possible by using pixels based on these new cavities. By fabricating a pixel which switches between two colors (for example red and black) then a flat-panel display may be fabricated by combining three sets of these pixels designed to switch between red and black, green and black, and blue and black respectively. The inherent color precludes the need for color filter arrays which are typically required for color LCDs. Additionally reflective displays, which are displays which use ambient light instead of backlighting, are particularly susceptible to pixel inefficiencies. Because the cavities of the invention can use greater than 90% of the incident light, they are excellent candidates for this application. These structures, when driven electrostatically, also exhibit a micro-electromechanical hysteresis which can be exploited to eliminate the need for transistors.

Other advantages and features of the invention will become apparent from the following description and from the claims.

Description

Fig. 1 is a diagram of layers a modulator.

Fig. 2 is a perspective view of cavities in a device.

Fig. 3 is a diagram is a side view of a pixel device.

Fig. 4 is a graph of the optical response for a cavity which appears black.

Fig. 5 is a graph of the optical response for a cavity which appears blue.

- 5 -

Fig. 6 is a graph of the optical response for a cavity which appears green.

Fig. 7 is a graph of the optical response for a cavity which appears red.

5 Fig. 8 is a graph of the optical response for a cavity which appears white.

Fig. 9 is a perspective view of a fragment of a reflective flat panel display.

10 Figs. 10a, 10b, 10c, 10d are perspective views of different spacers during fabrication.

Figs. 11a, 11b, 11c, 11d are also perspective views of different spacers during fabrication.

Figs. 12a, 12b, 12c, 12d are top views of a static graphic image.

15 Any thin film, medium, or substrate (which can be considered a thick film) can be defined in terms of a characteristic optical admittance. By considering only the reflectance, the operation of a thin film can be studied by treating it as an admittance transformer.
20 That is, a thin film or combination of thin films (the transformer) can alter the characteristic admittance of another thin film or substrate (the transformed film) upon which it is deposited. In this fashion a normally reflective film or substrate may have its characteristic
25 admittance altered (i.e. transformed) in such a way that its reflectivity is enhanced and/or degraded by the deposition of, or contact with, a transformer. In general there is always reflection at the interface between any combination of films, mediums, or substrates. The closer
30 the admittances of the two, the lower the reflectance at the interface, to the point where the reflectance is zero when the admittances are matched.

Referring to Fig. 1, reflector 100 (the transformed film) is separated from induced absorber 105

- 6 -

(th transformer), comprising films 104, 106, and 108, by variable thickness spacer 102. Incident medium 110 bounds the other side of induced absorber 105. Each of these thin films is micromachined in a fashion described
5 in the parent patent application. Induced absorber 105 performs two functions. The first is to match the admittances of reflector 100 and incident medium 110. This is accomplished via matching layer 108, which is used to transform the admittance of absorber 106 to that
10 of the incident medium 110, and via matching layer 104, which is used to transform the admittance of reflector 100 to that of absorber 106. The second function is the absorption of light. This is accomplished using absorber 106, which performs the function of attenuating light
15 which is incident upon it through the medium, as well as light which is incident upon it from the reflector.

The ability to alter the thickness T of spacer 102 allows the optical characteristics of the entire structure to be modified. Referring to Fig. 2, pixel 200
20 is shown in the driven state and pixel 202 in the undriven state. In this case induced absorber 206 (the transformer) resides on substrate 204 and reflector 208 (the transformed film) is a self-supporting structure. Application of a voltage causes reflector 208 to come
25 into contact or close proximity with induced absorber 206. Proper selection of materials and thicknesses will result in a complete transformation of the admittance of reflector 208 to that of substrate 204. Consequently, a range of frequencies of light 205, which is incident
30 through substrate 204, will be significantly absorbed by the pixel. With no voltage applied, reflector 208 returns to its normal structural state which changes the relative admittances of the reflector and the substrate. In this state (pixel 202) the cavity behaves more like a

- 7 -

resonant reflector, strongly reflecting certain frequencies while strongly absorbing others.

Proper selection of materials thus allows for the fabrication of pixels which can switch from reflecting any color (or combination of colors) to absorbing (e.g., blue to black), or from reflecting any color combination to any other color (e.g., white to red). Referring to Fig. 3, in a specific pixel design, substrate 402 is glass, matching layer 404 is a film of zirconium dioxide which is 54.46 nm thick, absorber 406 is a tungsten film 14.49 nm thick, matching layer 408 is a film of silicon dioxide 50 nm thick, spacer 400 is air, and reflector 410 is a film of silver at least 50 nm thick. Referring to Fig. 4, the optical response of the pixel is shown in the driven state, i.e., when reflector 410 is in contact with matching layer 408 resulting in a broad state of induced absorption. Referring to Figs. 5-8, the different color pixels are shown in respective undriven states which correspond to the reflection of blue, green, red, and white light, respectively. These responses correspond to undriven spacer thicknesses of 325, 435, 230, and 700 nm respectively

Referring to Fig. 9, a section of a full color reflective flat panel display 298 includes three kinds of pixels, R, G, and B. Each kind differs from the others only in the size of the undriven spacer which is determined during manufacture as described in the parent patent application. Induced absorber 300 resides on substrate 304, and reflector 308 is self-supporting. Monolithic backplate 302 provides a hermetic seal and can consist of a thick organic or inorganic film. Alternatively, the backplate may consist of a separate piece, such as glass, which has been aligned and bonded to the substrate. Electrodes may reside on this backplate so that the electromechanical performance of

- 8 -

the pixels may be modified. Incident light 310 is transmitted through optical compensation mechanism 306 and substrate 304 where it is selectively reflected or absorbed by a pixel. The display may be controlled and
5 driven by circuitry of the kind described in the parent application.

Optical compensation mechanism 306 serves two functions in this display. The first is that of mitigating or eliminating the shift in reflected color
10 with respect to the angle of incidence. This is a characteristic of all interference films and can be compensated for by using films with specifically tailored refractive indices or holographic properties, as well as films containing micro-optics; other ways may also be
15 possible. The second function is to supply a supplemental frontlighting source. In this way, additional light can be added to the front of the display when ambient lighting conditions have significantly diminished thus allowing the display to perform in
20 conditions ranging from intense brightness to total darkness. Such a frontlight could be fabricated using patterned organic emitters or edge lighting source coupled to a micro-optic array within the optical compensation film; other ways may also be possible.

25 The general process for fabrication of the devices is set forth in the parent application. Additional details of two alternative ways to fabricate spacers with different sizes are as follows; other ways may also be possible.

30 Both alternative processes involve the iterative deposition and patterning of a sacrificial spacer material which, in the final step of the larger process is, etched away to form an air-gap.

Referring to Fig. 10a, substrate 1000 is shown
35 with induced absorber 1002 already deposited and

- 9 -

photoresist 1004 deposited and patterned. Induced absorber 1002 is deposited using any number of techniques for thin film deposition including sputtering and e-beam deposition. The photoresist is deposited via spinning, and patterned by overexposure to produce a natural overhang resulting in a stencil. The result is that it may be used to pattern subsequently deposited materials using a procedure known as lift-off. Referring to Fig. 10b, spacer material 1006 has been deposited, resulting in excess spacer material 1008 on top of the stencil. Referring to Fig. 10c, the stencil along with the excess spacer material have been lifted off by immersing the device in a bath of a solvent such as acetone and agitating it with ultrasound. Referring to Fig. 10d, the process has begun again with new photoresist 1010 having been deposited patterned in a fashion such that new spacer 1012 is deposited adjacent to the old spacer 1006. Repeating the process once more results in spacers with three different thicknesses. Referring to Fig. 10d, the process has begun again with new photoresist 1010 having been deposited patterned in a fashion such that new spacer 1012, with a different thickness, is deposited adjacent to the old spacer 1006.

Referring to Fig. 11a, substrate 1000 is shown with induced absorber 1102 already deposited. Spacer materials 1104, 1106, and 1108 have also been deposited and patterned by virtue of lift-off stencil 1110. The spacer materials have a thickness corresponding to the maximum of the three thicknesses required for the pixels. Referring to Fig. 11b, the stencil along with the excess material has been lifted off and new photoresist 1112 has been deposited and patterned such that spacer 1104 has been left exposed. Referring to Fig. 11c, spacer material 1104 has been etched back via one of a number of techniques which include wet chemical etching, and

- 10 -

reactiv ion etching. Only a portion f the required spacer material is etched away, with the remainder to be etched in a subsequent etch step. Photoresist 1112 is subsequently removed using a similar technique.

5 Referring to Fig. 11d, new photoresist 1114 has been deposited and patterned exposing spacers 1104 and 1106. The entire etch of spacer 1106 is performed in this step, and the etch of spacer 1104 is completed. Photoresist 1114 is subsequently removed and the process is complete.

10 Other embodiments are within the scope of the following claims.

For example, the spacer material need not ultimately be etched away but may remain instead a part of the finished device. In this fashion, and using the
15 previously described patterning techniques, arbitrary patterns may be fabricated instead of arrays of simple pixels. Full color static graphical images may thus be rendered in a method which is analogous to a conventional printing process. In conventional printing, an image is
20 broken up into color separations which are basically monochrome graphical subsets of the image, which correspond to the different colors represented, i.e., a red separation, a blue separation, a green separation, and a black separation. The full-color image is produced
25 by printing each separation using a different colored ink on the same area.

Alternatively, in a process which we will call "Iridescent Printing", the different separations are composed of layers of thin films which correspond to the
30 IMod design described here and those in the referenced patent. Patterning or printing a combination of colors or separations on the same area, allows for brilliant full-color images to be produced.

Referring to Fig. 12a, a square substrate is shown
35 with area 1200 representing the portion of the substrate

- 11 -

which has been patterned with a thin film stack optimized for black. Referring to Fig. 12b, the substrate has been subsequently patterned with a thin film stack optimized for red in area 1202. Referring to Fig. 12c, the substrate has been subsequently patterned with a thin film stack optimized for green in area 1204. Referring to Fig. 12d, the substrate has been subsequently patterned with a thin film stack optimized for blue in area 1206.

Alternatively, a simpler process can be obtained if only the induced absorber design is used. In this process, the entire substrate is first coated with the induced absorber stack. Subsequent steps are then used to pattern the spacer material only, using the aforementioned techniques. After the desired spacers, i.e., colors are defined, a final deposition of a reflector is performed.

The brightness of different colors can be altered by varying the amount of black interspersed with the particular color i.e. spatial dithering. The images also exhibit the pleasing shift of color with respect to viewing angle known as iridescence.

In another example, a reflective flat panel display may also be fabricated using a single kind of pixel instead of three. Multiple colors, in this case, are obtained through fabricating the pixels in the form of continuously tunable or analog interferometric modulators as described in the parent patent application. In this fashion, any individual pixel may, by the application of the appropriate voltage, be tuned to reflect any specific color. This would require that the array be fabricated on a substrate along with electronic circuitry, or directly on the surface of an integrated circuit, in order to provide a charge storage mechanism. This approach, though it requires a more complicated

- 12 -

driving schem relying on analog voltages, provides superior resolution. It would also find application in a projection system.

What is claimed is:

- 13 -

Claims

1. An interferometric modulator cavity comprising a reflector, and an induced absorber.
- 5 2. The cavity of claim 1 wherein the reflector comprises a film of metal.
3. The cavity of claim 1 wherein the reflector comprises a dielectric film.
4. The cavity of claim 1 wherein the reflector
10 comprises a semiconducting film.
5. The cavity of claim 1 wherein the reflector comprises a combination of at least two of a metal film, a dielectric film, and a semiconducting film.
6. The cavity of claim 1 wherein the induced
15 absorber comprises a sandwich of an absorber between two matching layers.
7. The cavity of claim 6 wherein one of the matching layers resides at the boundary of the absorber with an incident medium and the other matching layer
20 resides at the boundary of the absorber with the reflector.
8. The cavity of claim 6 wherein at least one of the matching layers comprises a film of metal.
9. The cavity of claim 6 wherein at least one of
25 the matching layers comprises a dielectric film.
10. The cavity of claim 6 wherein at least one of the matching layers comprises a semiconducting film.
11. The cavity of claim 6 wherein at least one of the matching layers comprises a combination of at least
30 two of a metal film, a dielectric film, and a semiconducting film.
12. The cavity of claim 6 wherein the absorber comprises a high loss film such as a metal.
13. The cavity of claim 6 wherein the absorber
35 comprises a high loss film such as a semiconductor.

- 14 -

14. The cavity of claim 6 wherein the absorber comprises a combination of a metal and semiconducting film.

15. The cavity of claim 1 further comprising a substrate.

16. The cavity of claim 15 wherein the substrate comprises a transparent incident medium.

17. The cavity of claim 15 wherein the substrate comprises an opaque medium.

18. The cavity of claim 15 wherein the induced absorber resides on the substrate.

19. The cavity of claim 15 wherein the reflector resides on the substrate.

20. The cavity of claim 15 wherein the substrate comprises a reflector.

21. A direct view reflective flat panel display comprising an array of interferometric modulators.

22. The display of claim 21 wherein the array comprises a single set of analog interferometric modulators arranged to tune to any specific reflective state.

23. The display of claim 21 wherein the array comprises sets of the interferometric modulators the respective sets being arranged to switch between different pairs of reflective states.

24. The display of claim 21 wherein the brightness of each of the modulators is controlled by pulse width modulation.

25. The display of claim 21 wherein the brightness of each of the modulators pixel is controlled by spatial dithering.

26. The display of claim 21 wherein the brightness of each of the modulators is controlled by a combination of pulse width modulation and spatial dithering.

- 15 -

27. The display of claim 21 wherein the array is sealed by a backplane.

28. The display of claim 21 where the backplane comprises a monolithic element.

5 29. The display of claim 27 wherein the backplane is attached.

30. The display of claim 27 wherein the backplane supports electrodes which modify the electromechanical response of the pixels.

10 31. The display of claim 21 where each of the modulators is actuated by electrostatic forces.

32. The display of claim 21 wherein each of the modulators is actuated by piezoelectric forces.

15 33. The display of claim 21 wherein each of the modulators is actuated by magnetic forces.

34. The display of claim 21 for use in a projection system.

35. The display of claim 21 wherein an optical compensation mechanism is used to mitigate or eliminate a
20 shift in color with respect to viewing angle, and to .

36. The display of claim 21 wherein an optical compensation mechanism is used to provide supplemental frontlighting.

37. The display of claim 21 wherein an optical
25 compensation mechanism is used to mitigate or eliminate a shift in color with respect to viewing angle, and to provide supplemental frontlighting.

38. The display of claim 21 wherein the array is fabricated on an integrated circuit.

30 39. The display of claim 21 wherein the array is fabricated on the substrate along with electronic circuitry.

- 16 -

40. A process for fabricating adjacent spacers of different thicknesses on a substrate comprising using a lift-off technique to pattern the spacers which are deposited separately, each deposition providing
5 a different thickness of spacer.

41. A process for fabricating adjacent spacers of different thicknesses on a substrate comprising using a patterned photoresist to allow for an etching process to selectively etch back the thickness of
10 a spacer which was deposited in a single deposition.

42. A full-color static graphical image comprising
an array of interferometric modulator cavities, each cavity including
15 a reflector, and
an induced absorber, the induced absorber including a spacer having a thickness that defines a color associated with the cavity.

43. The image of claim 42 in which the brightness
20 of different cavities is determined by spatial dithering.

44. A full-color static graphical image comprising separate patterns of spacers or of interferometric modulator cavities and spacers, for each pattern the spacer having a thickness which defines a
25 color associated with the pattern which when all patterns are combined produces the image.

45. The image of claim 44 in which the brightness of the different patterns is determined by spatial dithering.

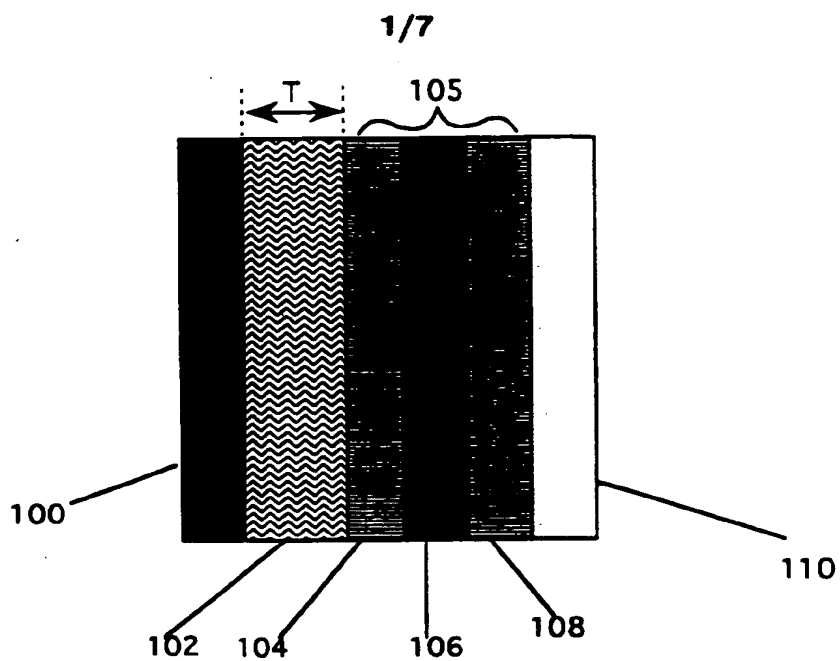


FIG. 1

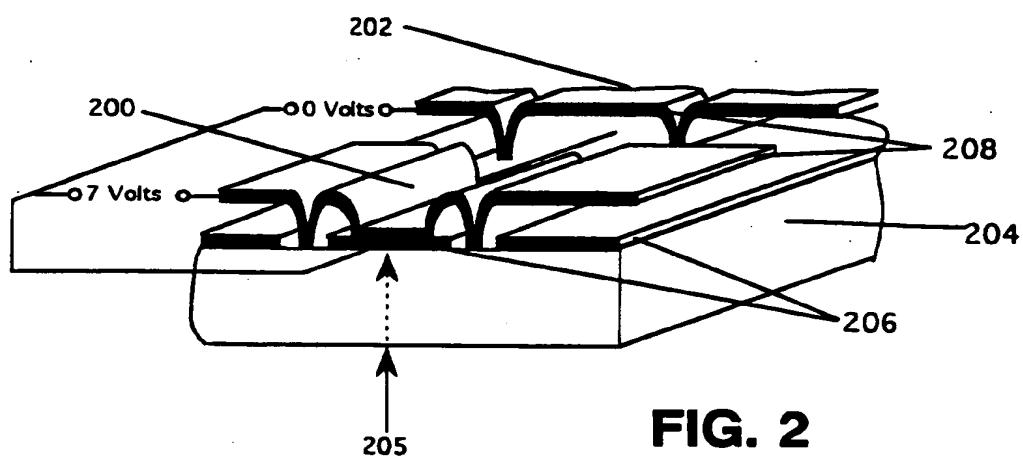


FIG. 2

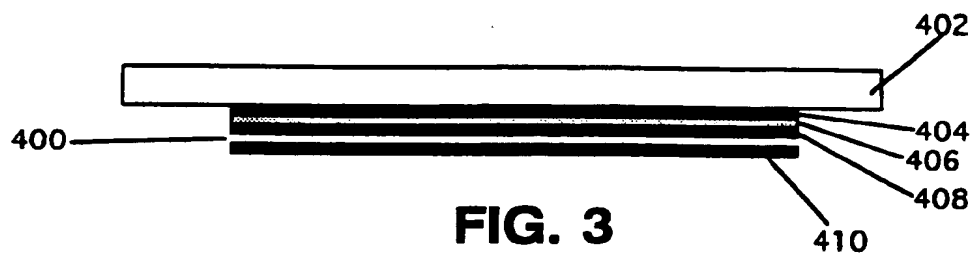
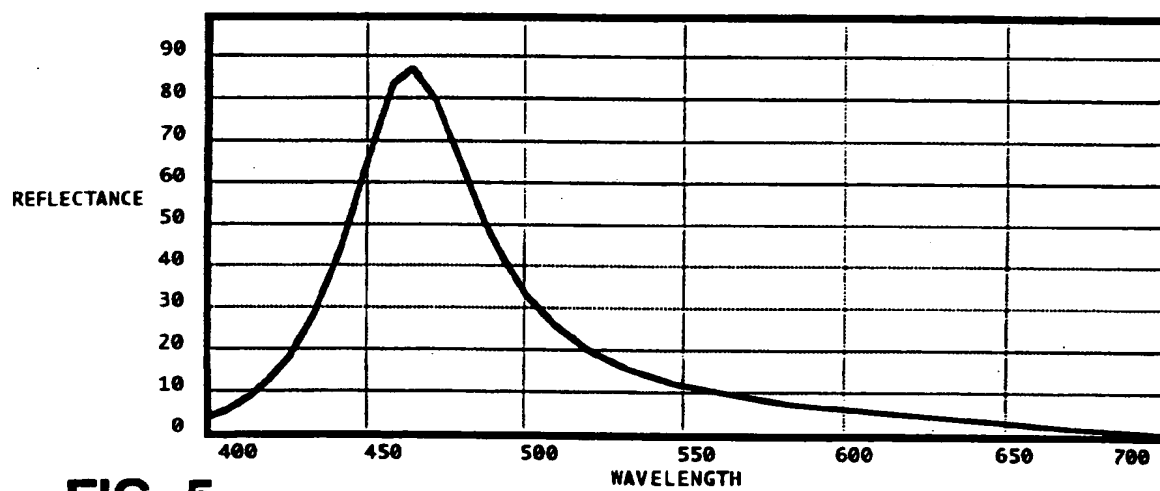
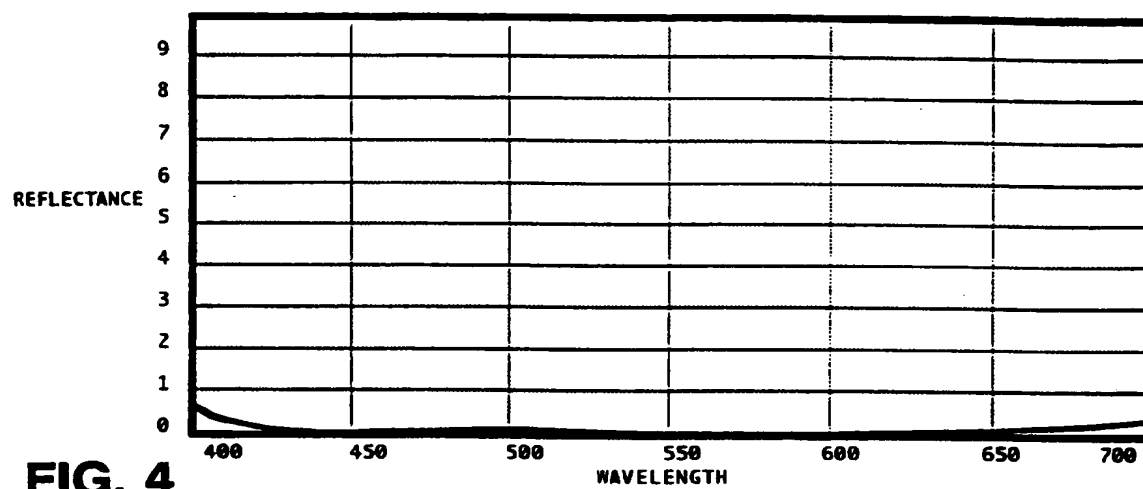
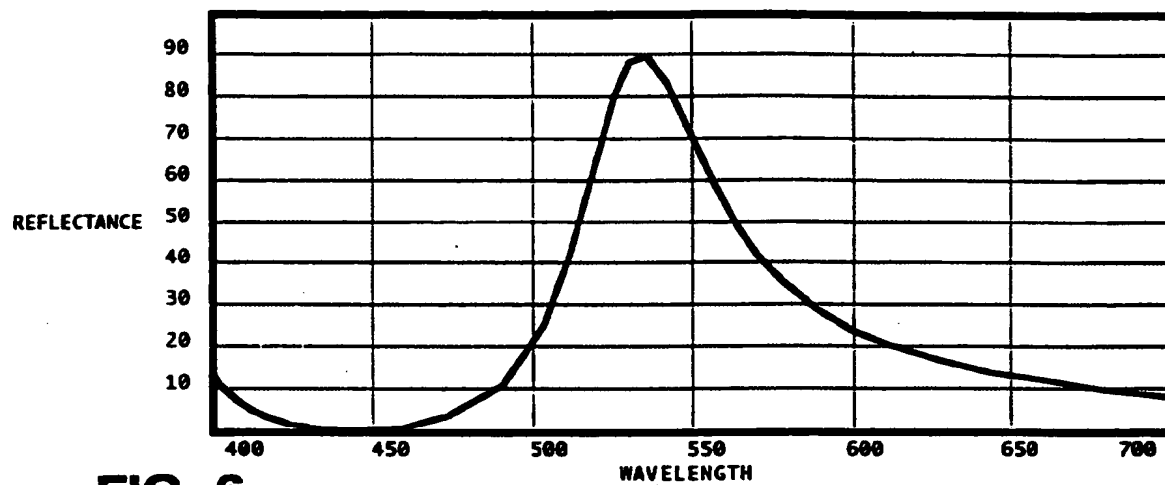
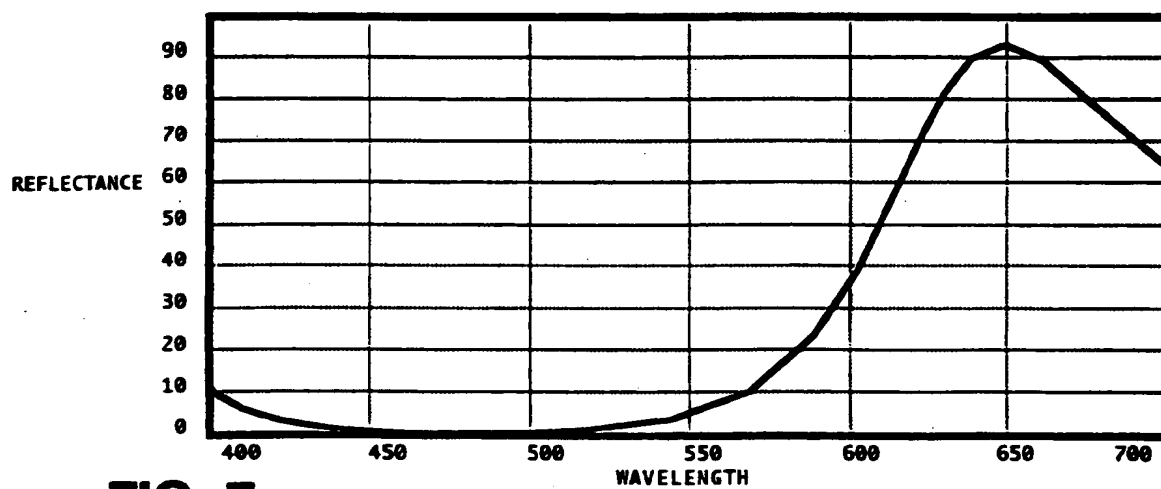


FIG. 3

2/7



3/7

**FIG. 6****FIG. 7**

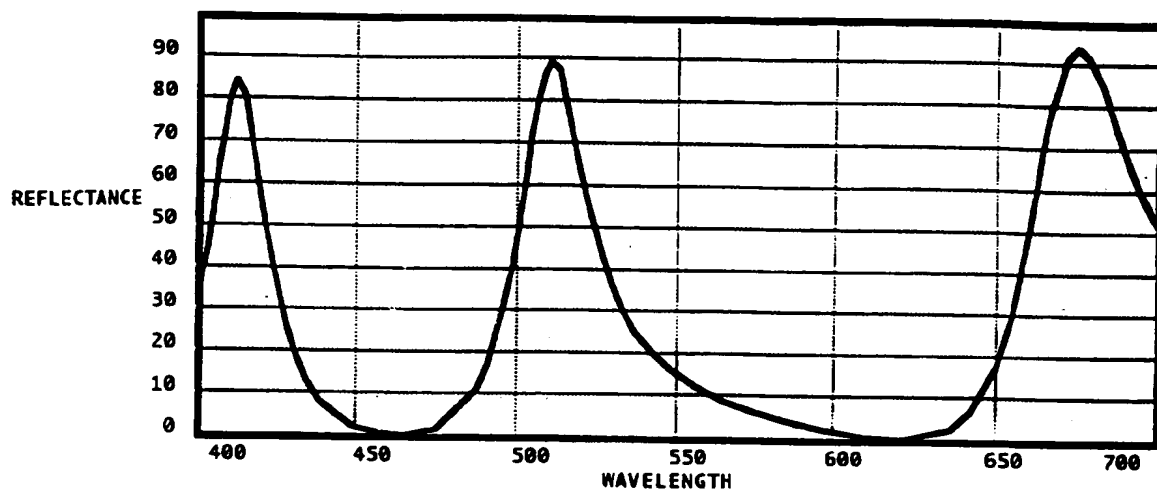


FIG. 8

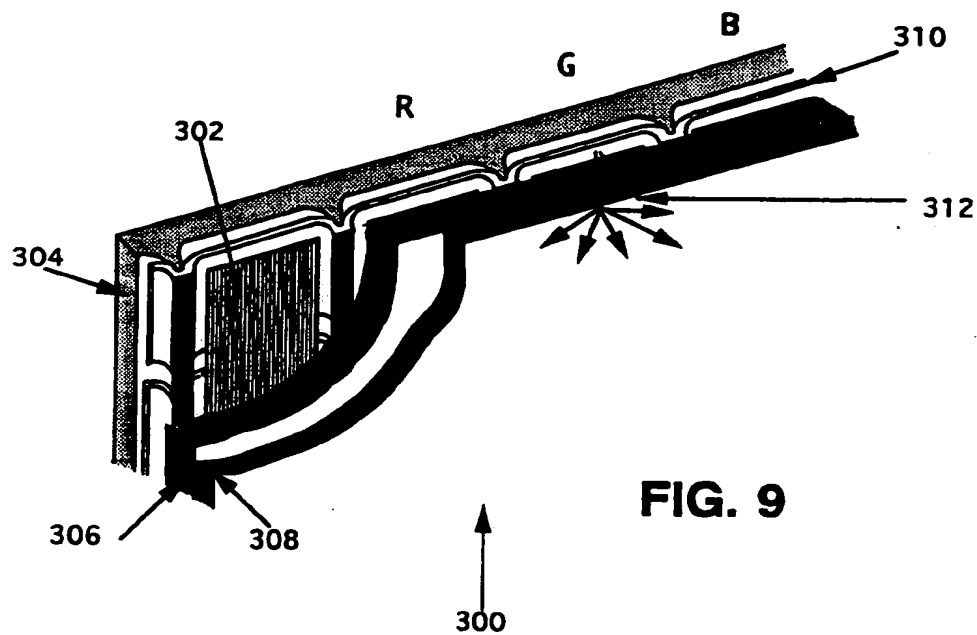


FIG. 9

5/7

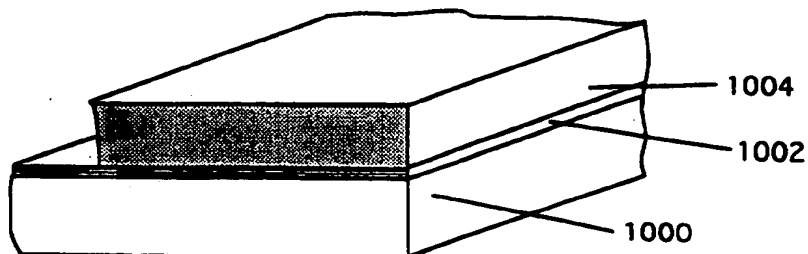


FIG. 10a

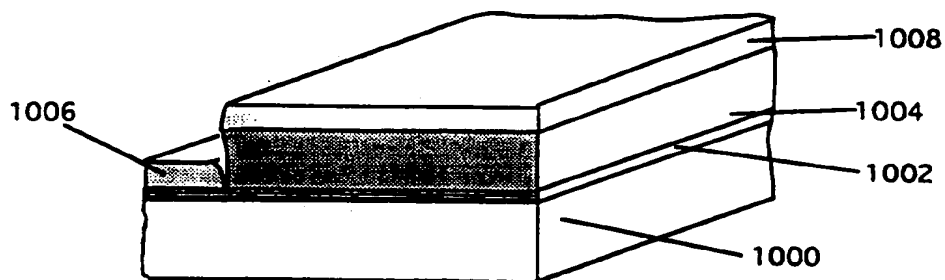


FIG. 10b

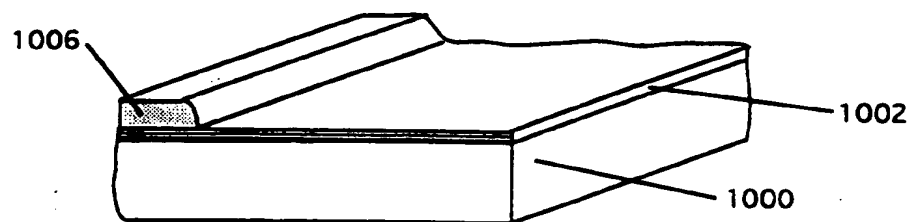


FIG. 10c

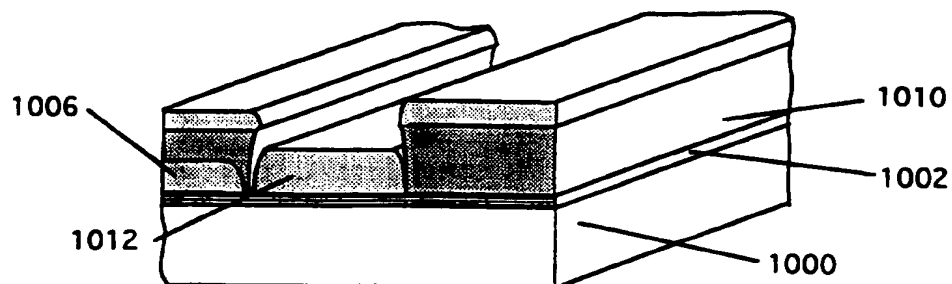


FIG. 10d

6/7

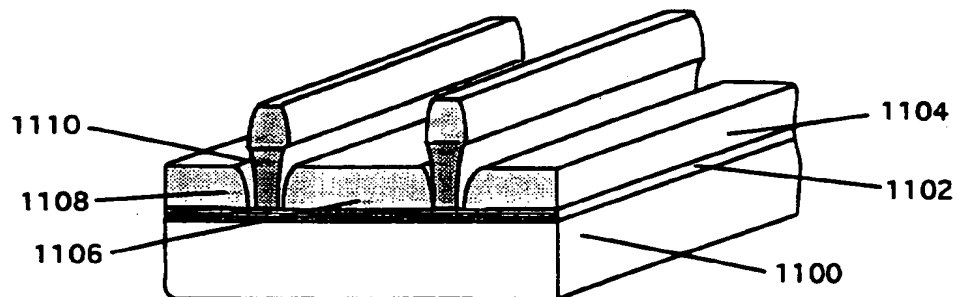


FIG. 11a

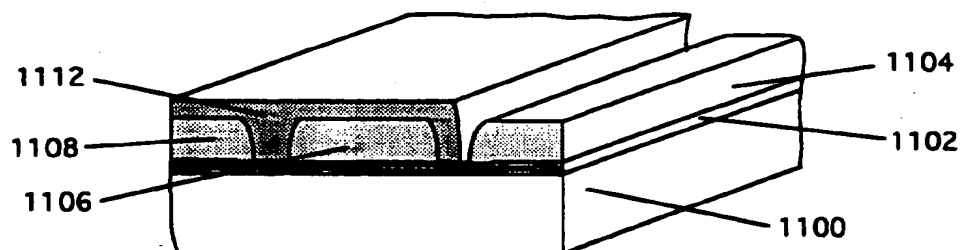


FIG. 11b

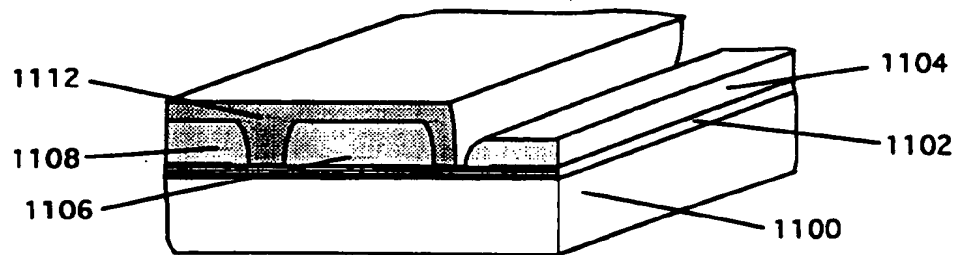


FIG. 11c

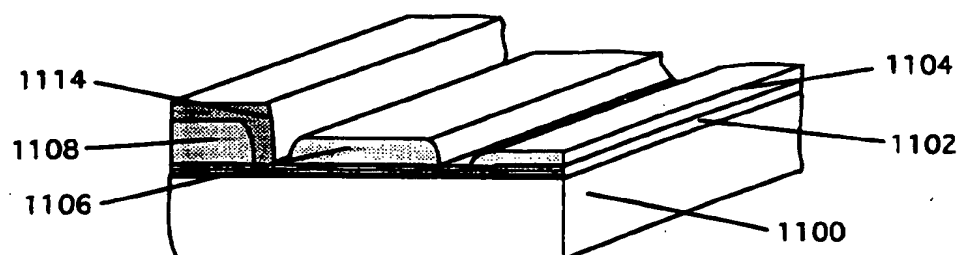


FIG. 11d

7/7

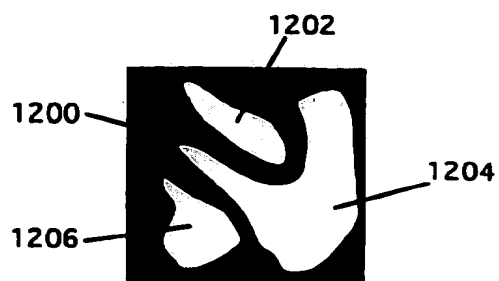


FIG. 12a

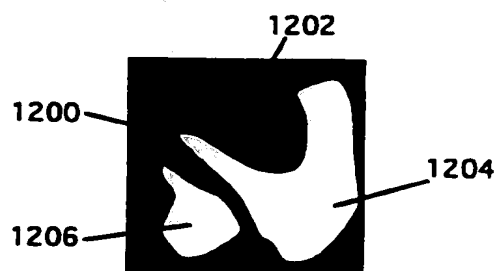


FIG. 12b

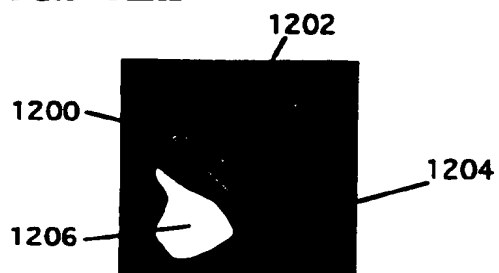


FIG. 12c

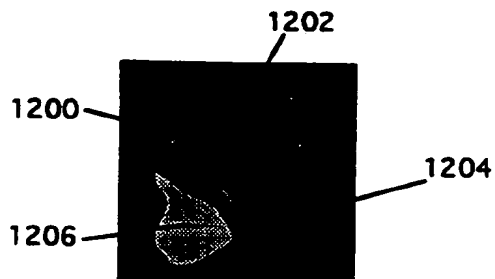


FIG. 12d